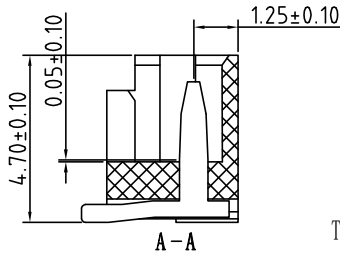
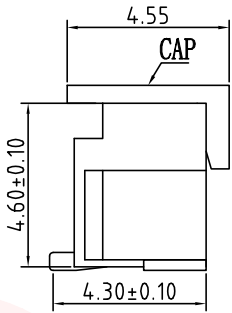
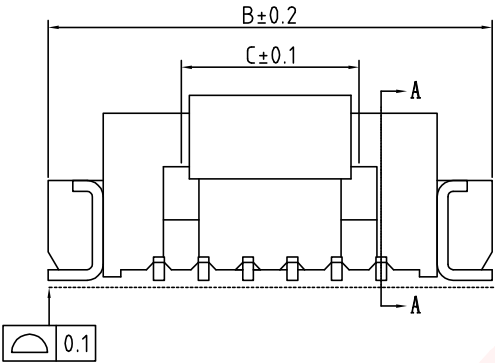




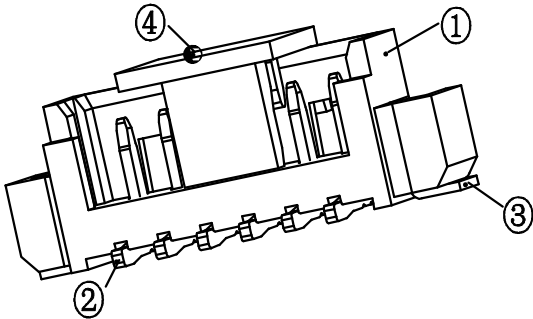
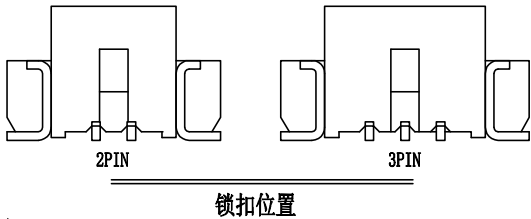
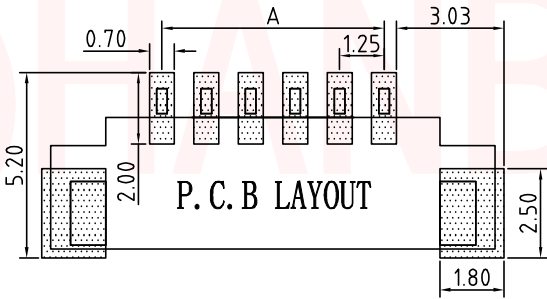
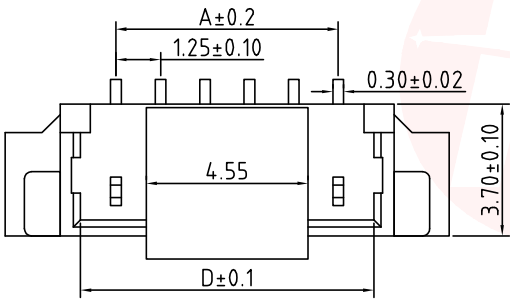
REV.	ECN NO OR DESCRIPTION	REVISED	DATE



1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
2. 锁扣窗口：2~3PIN为1个，≥4PIN为2个。
3. 不同PIN位吸盖加入/取出力有差异，实属正常现象。

TABLE:

CSG PART NO.	PIN位	A	B	C	D
WAFER-MX125LT-2A	2PIN	1.25	7.50		3.25
WAFER-MX125LT-3A	3PIN	2.50	8.75		4.50
WAFER-MX125LT-4A	4PIN	3.75	10.00	2.50	5.75
WAFER-MX125LT-5A	5PIN	5.00	11.25	3.75	7.00
WAFER-MX125LT-6A	6PIN	6.25	12.50	5.00	8.25
WAFER-MX125LT-7A	7PIN	7.50	13.75	6.25	9.50
WAFER-MX125LT-8A	8PIN	8.75	15.00	7.50	10.75
WAFER-MX125LT-9A	9PIN	10.00	16.25	8.75	12.00
WAFER-MX125LT-10A	10PIN	11.25	17.50	10.00	13.25
WAFER-MX125LT-11A	11PIN	12.50	18.75	11.25	14.50
WAFER-MX125LT-12A	12PIN	13.75	20.00	12.50	15.75
WAFER-MX125LT-13A	13PIN	15.00	21.25	13.75	17.00
WAFER-MX125LT-14A	14PIN	16.25	22.50	15.00	18.25
WAFER-MX125LT-15A	15PIN	17.50	23.75	16.25	19.50
WAFER-MX125LT-16A	16PIN	18.75	25.00	17.50	20.75



技术参数
间距: 1.25
温度范围: -25~+85℃
额定电压: 125V AC, DC
额定电流: 1.0A AC, DC
接触电阻: 20mΩ
绝缘电阻: 100MΩ
耐压: 500V AC/minute

UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD			
DECIMALS: ANGLES:		TITLE: WAFER MX 1.25立贴			
X :±0.20	X :±2°	DWN	xiong	PART NO. WAFER-MX125LT-NA	
X.X :±0.10	X.X :±1°	CHKD	lee	SCALE:1:1	UNIT: mm
X.XX :±0.05		APVD	wang	SIZE: A4	SHEET:10F 1
CUSTOMER COPY					